TE李询TS3A 44159供应商
捷多邦，专业PCB打样工厂，24小时加急出货TS3A44159
$0.45-\Omega$ QUAD SPDT ANALOG SWITCH
INSTRUMENTS
QUAD－CHANNEL 2：1 MULTIPLEXER／DEMULTIPLEXER WITH TWO CONTROLS
www．ti．com

## FEATURES

－Specified Break－Before－Make Switching
－Low ON－State Resistance（＜0．5 $\Omega$ ）
－Control Inputs Are 1．8－V Logic Compatible
－Low Charge Injection
－Excellent ON－State Resistance Matching
－Low Total Harmonic Distortion（THD）
－ $1.65-\mathrm{V}$ to $4.3-\mathrm{V}$ Single－Supply Operation
－Latch－Up Performance Exceeds 100 mA Per JESD 78，Class II
－ESD Performance Tested Per JESD 22
－2000－V Human－Body Model （A114－B，Class II）
－1000－V Charged－Device Model（C101）

## APPLICATIONS

－Cell Phones
－PDAs
－Portable Instrumentation
－Audio and Video Signal Routing
－Low－Voltage Data－Acquisition Systems
－Communication Circuits
－Modems
－Hard Drives
－Computer Peripherals
－Wireless Terminals and Peripherals


## DESCRIPTION／ORDERING INFORMATION

The TS3A44159 is a quad single－pole double－throw（SPDT）analog switch with two control inputs，which is designed to operate from 1.65 V to 4.3 V ．This device is also known as a dual double－pole double－throw（DPDT） configuration．It offers low ON －state resistance and excellent ON －state resistance matching with the break－before－make feature，to prevent signal distortion during the transferring of a signal from one channel to another．The device has an excellent total harmonic distortion（THD）performance and consumes very low power．These features make this device suitable for portable audio applications

ORDERING INFORMATION

| $\mathbf{T}_{\mathbf{A}}$ | PACKAGE ${ }^{(1)}$ |  | ORDERABLE PART NUMBER | TOP－SIDE MARKING |
| :--- | :--- | :--- | :--- | :--- |
| $-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ | RGT－QFN | Tape and reel | TS3A44159RGTR | ZWH |
|  | RSV－QFN | Tape and reel | TS3A44159RSVR | ZWH |
|  | PW－TSSOP | Tape and reel | TS3A44159PWR | YC4159 |

（1）For the most current package and ordering information，see the Package Option Addendum at the end of this document，or see the TI website at www．ti．com．

[^0]SUMMARY OF CHARACTERISTICS ${ }^{(1)}$

| Configuration | Quad 2:1 Multiplexer/Demultiplexer $(4 \times$ SPDT or $2 \times$ DPDT $)$ |
| :---: | :---: |
| Number of channels | 4 |
| ON-state resistance ( $\mathrm{ron}_{\text {) }}$ ) | $0.45 \Omega$ (max) |
| ON-state resistance match ( $\Delta \mathrm{r}_{\text {on }}$ ) | $0.07 \Omega$ (max) |
| ON-state resistance flatness ( $\mathrm{roN}_{\text {(flat) }}$ ) | $0.1 \Omega$ (max) |
| Turn-on/turn-off time ( $\mathrm{t}_{\text {ON }} / \mathrm{t}_{\text {OFF }}$ ) | $23 \mathrm{~ns} / 32 \mathrm{~ns}$ |
| Break-before-make time ( $\mathrm{t}_{\text {BBM }}$ ) | 30 ns |
| Charge injection ( $\mathrm{Q}_{\mathrm{C}}$ ) | 139 pC |
| Bandwidth (BW) | 35 MHz |
| OFF isolation ( $\mathrm{O}_{\text {ISO }}$ ) | $-71 \mathrm{~dB}$ |
| Crosstalk ( $\mathrm{X}_{\text {TALK }}$ ) | -73 dB |
| Total harmonic distortion (THD) | 0.003\% |
| Power-supply current ( $\mathrm{I}_{+}$) | $0.4 \mu \mathrm{~A}$ |
| Package option | 16-pin QFN |

(1) $\mathrm{V}_{+}=4.3 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$

## FUNCTION TABLE

| IN | NC TO COM, <br> COM TO NC | NO TO COM, <br> COM TO NO |
| :---: | :---: | :---: |
| L | ON | OFF |
| H | OFF | ON |

LOGIC DIAGRAM


Absolute Maximum Ratings ${ }^{(1)(2)}$
over operating free-air temperature range (unless otherwise noted)

|  |  |  | MIN | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{+}$ | Supply voltage range ${ }^{(3)}$ |  | -0.5 | 4.6 | V |
| $\begin{aligned} & \hline \mathrm{V}_{\mathrm{NC}} \\ & \mathrm{~V}_{\mathrm{NO}} \\ & \mathrm{~V}_{\mathrm{COM}} \\ & \hline \end{aligned}$ | Analog voltage range ${ }^{(3)(4)(5)}$ |  | -0.5 | $\mathrm{V}_{+}+0.5$ | V |
| $\mathrm{I}_{\mathrm{K}}$ | Analog port diode current | $\mathrm{V}_{\mathrm{NC}}, \mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}<0$ | -50 |  | V |
| $\mathrm{I}_{\mathrm{NC}}$ | ON-state switch current | $\mathrm{V}_{\mathrm{NC}}, \mathrm{V}_{\mathrm{NO}}, \mathrm{V}_{\mathrm{COM}}=0$ to $\mathrm{V}_{+}$ | -200 | 200 | mA |
| $\begin{aligned} & \mathrm{I}_{\mathrm{NO}} \\ & \mathrm{I}_{\mathrm{COM}} \end{aligned}$ | ON-state peak switch current ${ }^{(6)}$ |  | -400 | 400 |  |
| $\mathrm{V}_{1}$ | Digital input voltage range |  | -0.5 | 4.6 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | Digital input clamp current ${ }^{(3)}{ }^{(4)}$ | $\mathrm{V}_{1}<0$ | -50 |  | mA |
| $I_{+}$ | Continuous current through $\mathrm{V}_{+}$ |  |  | 100 | mA |
| $\mathrm{I}_{\mathrm{GND}}$ | Continuous current through GND |  | -100 |  | mA |
| $\theta_{\text {JA }}$ | Package thermal impedance ${ }^{(7)}$ | PW package |  | 108 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  |  | RGT package |  | TBD |  |
|  |  | RSV package |  | TBD |  |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  | -65 | 150 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.
(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(3) All voltages are with respect to ground, unless otherwise specified.
(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
(5) This value is limited to 4.6 V maximum.
(6) Pulse at 1 -ms duration $<10 \%$ duty cycle
(7) The package thermal impedance is calculated in accordance with JESD 51-7.
$0.45-\Omega$ QUAD SPDT ANALOG SWITCH
QUAD-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER WITH TWO CONTROLS
Electrical Characteristics for 4.3-V Supply ${ }^{(1)}$
$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | V+ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\begin{gathered} \mathrm{v}_{\mathrm{COM}}, \\ \mathrm{v}_{\mathrm{NO}}, \mathrm{~V}_{\mathrm{NC}} \end{gathered}$ |  |  |  |  | 0 |  | $V_{+}$ | $\Omega$ |
| ON-state resistance | $\mathrm{r}_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.5 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 17 | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 0.3 | 0.45 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.5 |  |
| ON-state resistance match between channels | $\Delta \mathrm{r}_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.5 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 17 | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 0.05 | 0.07 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.1 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1 \mathrm{~V}, \\ & 1.5 \mathrm{~V}, 2.5 \mathrm{~V}, \\ & \mathrm{I}_{\text {COM }}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 18 | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 0.02 | 0.1 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.1 |  |
| NC, NO OFF leakage current | ${ }^{1} \mathrm{NO}$ (OFF), <br> $\mathrm{I}_{\mathrm{NC}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=3.0 \mathrm{~V}, \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, \\ & \hline \end{aligned}$ | See Figure 18 | $25^{\circ} \mathrm{C}$ | 4.3 V | -20 | 5 | 20 |  |
|  |  |  |  | Full |  | -90 |  | 90 | nA |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}$, <br> $\mathrm{V}_{\text {Com }}=$ Open, <br> or <br> $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=3.0 \mathrm{~V}$, <br> $\mathrm{V}_{\text {Com }}=$ Open, | See Figure 19 | $25^{\circ} \mathrm{C}$ | 4.3 V | -20 | 5 | 20 |  |
|  |  |  |  | Full |  | -90 |  | 90 | nA |
| COM ON leakage current | $\mathrm{I}_{\text {COM (ON }}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0.3 \mathrm{~V}$, <br> or <br> $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=3.0 \mathrm{~V}$, | See Figure 19 | $25^{\circ} \mathrm{C}$ | 4.3 V | -20 | 5 | 20 | nA |
|  |  |  |  | Full |  | -90 |  | 90 |  |
| Digital Control Inputs (IN1-2, IN3-4) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full | 4.3 V | 1 |  | 4.3 | V |
| Input logic low | $\mathrm{V}_{\mathrm{IL}}$ |  |  | Full | 4.3 V | 0 |  | 0.4 | V |
| Input leakage current | $\mathrm{I}_{\text {IH }}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 0.5 | 10 | nA |
|  |  |  |  | Full |  |  |  | 50 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 4.3-V Supply (continued)

$\mathrm{T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | $\mathrm{t}_{\mathrm{on}}$ | $\begin{aligned} & \mathrm{V}_{\text {Сом }}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 17 | 23 | ns |
|  |  |  |  | Full |  |  |  | 25 |  |
| Turn-off time | $t_{\text {OFF }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 12 | 32 | ns |
|  |  |  |  | Full |  |  |  | 35 |  |
| Break-before-make time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 4.3 V | 2 | 9 | 30 | ns |
|  |  |  |  | Full |  | 1 |  | 35 |  |
| Charge injection | $Q_{C}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \end{aligned}$ | $C_{L}=1 \mathrm{nF}$ | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 139 |  | pC |
| NC, NO off capacitance | $\mathrm{C}_{\text {NC(OFF) }}$, $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, <br> Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 50 |  | pF |
| NC, NO ON capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{ON})}$, <br> $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, <br> Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 160 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM (ON) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+} \text {or GND, } \\ & \text { Switch ON, } \end{aligned}$ | See Figure 17 | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 160 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND |  | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 2.5 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 35 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch OFF | $25^{\circ} \mathrm{C}$ | 4.3 V |  | -71 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch ON | $25^{\circ} \mathrm{C}$ | 4.3 V |  | -73 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\mathrm{f}=20 \mathrm{~Hz}$ to 20 kHz | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 0.003 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 4.3 V |  | 0.15 | 0.4 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 1.2 |  |

$0.45-\Omega$ QUAD SPDT ANALOG SWITCH
QUAD-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER WITH TWO CONTROLS
SCDS225-MARCH 2007

## Electrical Characteristics for 3.3-V Supply ${ }^{(1)}$

$\mathrm{V}_{+}=3 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{T}_{\text {A }}$ | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\begin{gathered} \mathrm{V}_{\mathrm{COM}}, \\ \mathrm{~V}_{\mathrm{NO}}, \mathrm{~V}_{\mathrm{NC}} \end{gathered}$ |  |  |  |  | 0 |  | $\mathrm{V}_{+}$ | $\Omega$ |
| ON-state resistance | $r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.0 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 17 | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.37 | 0.55 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.6 |  |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.0 \mathrm{~V}, 0.8 \\ & \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, <br> See Figure 17 | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.06 | 0.07 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.1 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {onflat) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.0 \mathrm{~V}, 0.8 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 18 | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.05 | 0.1 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.1 |  |
| NC, NO OFF leakage current | $\mathrm{I}_{\text {NO(OFF) }}$, $\mathrm{I}_{\mathrm{NC}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=3.0 \mathrm{~V}, \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, \\ & \hline \end{aligned}$ | See Figure 18 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 5 | 15 |  |
|  |  |  |  | Full |  | -50 |  | 50 | nA |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=3.0 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | See Figure 19 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 5 | 15 |  |
|  |  |  |  | Full |  | -50 |  | 50 | nA |
| COM ON leakage current | ICOM(ON) | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0.3 \mathrm{~V}$, <br> or <br> $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\text {Сом }}=3.0 \mathrm{~V}$, | See Figure 19 | $25^{\circ} \mathrm{C}$ | 3.6 V | -15 | 5 | 15 |  |
|  |  |  |  | Full |  | -50 |  | 50 | nA |
| Digital Control Inputs (IN1-2, IN3-4) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | 1.25 |  | 4.3 | V |
| Input logic low | $\mathrm{V}_{\mathrm{IL}}$ |  |  | Full |  | 0 |  | 0.8 | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 3.6 V |  | 0.5 | 10 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 50 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 3.3-V Supply (continued)

$\mathrm{V}_{+}=3 \mathrm{~V}$ to $3.6 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | $\mathrm{t}_{\mathrm{oN}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 3 V |  | 20 | 38 |  |
|  |  |  |  | Full | $\begin{aligned} & 3 \mathrm{~V} \text { to } \\ & 3.6 \mathrm{~V} \end{aligned}$ |  |  | 40 | ns |
| Turn-off time | toff | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 3 V |  | 14 | 34 |  |
|  |  |  |  | Full | $\begin{aligned} & 3 \mathrm{~V} \text { to } \\ & 3.6 \mathrm{~V} \end{aligned}$ |  |  | 35 | ns |
| Break-before-make time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 3 V | 3 | 11 | 35 | ns |
|  |  |  |  | Full | $\begin{aligned} & 3 \mathrm{~V} \text { to } \\ & 3.6 \mathrm{~V} \end{aligned}$ | 2 |  | 55 |  |
| Charge injection | $\mathrm{Q}_{\mathrm{C}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \\ & \hline \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=1 \mathrm{nF}$ | $25^{\circ} \mathrm{C}$ | 3 V |  | 109 |  | pC |
| NC, NO OFF capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{OFF})}$, $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 3 V |  | 51 |  | pF |
| NC, NO ON capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{ON})}$, <br> $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 3 V |  | 162 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+} \text {or GND, } \\ & \text { Switch ON, } \end{aligned}$ | See Figure 17 | $25^{\circ} \mathrm{C}$ | 3 V |  | 162 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND |  | $25^{\circ} \mathrm{C}$ | 3 V |  | 2.5 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON | $25^{\circ} \mathrm{C}$ | 3 V |  | 35 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch OFF | $25^{\circ} \mathrm{C}$ | 3 V |  | -71 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch ON | $25^{\circ} \mathrm{C}$ | 3 V |  | -73 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\mathrm{f}=20 \mathrm{~Hz}$ to 20 kHz | $25^{\circ} \mathrm{C}$ | 3 V |  | 0.003 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 3.6 V |  | 0.015 | 0.2 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 0.7 |  |

TS3A44159
$0.45-\Omega$ QUAD SPDT ANALOG SWITCH
QUAD-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER WITH TWO CONTROLS
SCDS225-MARCH 2007

## Electrical Characteristics for 2.5-V Supply ${ }^{(1)}$

$\mathrm{V}_{+}=2.3 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\begin{gathered} \mathrm{V}_{\mathrm{COM}}, \\ \mathrm{~V}_{\mathrm{NO}}, \mathrm{~V}_{\mathrm{NC}} \end{gathered}$ |  |  |  |  | 0 |  | $V_{+}$ | $\Omega$ |
| ON-state resistance | $r_{\text {on }}$ | $\mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.8 \mathrm{~V} \text {, }$$\mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA} \text {, }$ | Switch ON, See Figure 17 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 0.45 | 0.6 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.7 |  |
| ON -state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.8 \mathrm{~V}, 0.8 \mathrm{~V} \text {, } \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 17 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 0.045 | 0.07 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.1 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.8 \mathrm{~V}, 0.8 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 18 | $25^{\circ} \mathrm{C}$ | 2.3 V |  | 0.06 | 0.15 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.2 |  |
| NC, NO OFF leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$, $I_{\text {NC(OFF) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=2.3 \mathrm{~V}, \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, \end{aligned}$ | See Figure 18 | $25^{\circ} \mathrm{C}$ | 2.7 V | -10 | 0.5 | 10 |  |
|  |  |  |  | Full |  | -20 |  | 20 | nA |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=2.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\text { Open, } \end{aligned}$ | See Figure 19 | $25^{\circ} \mathrm{C}$ | 2.7 V | -10 | 0.1 | 10 |  |
|  |  |  |  | Full |  | -20 |  | 20 | nA |
| COM ON leakage current | $\mathrm{I}_{\text {COM(ON })}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0.3 \mathrm{~V}$, <br> or <br> $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\mathrm{COM}}=2.3 \mathrm{~V}$, | See Figure 19 | $25^{\circ} \mathrm{C}$ | 2.7 V | -10 | 0.1 | 10 |  |
|  |  |  |  | Full |  | -20 |  | 20 | nA |
| Digital Control Inputs (IN1-2, IN3-4) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{IH}}$ |  |  | Full |  | 1.2 |  | 4.3 | V |
| Input logic low | $\mathrm{V}_{\text {IL }}$ |  |  | Full |  | 0 |  | 0.6 | V |
| Input leakage current | $\mathrm{I}_{\mathrm{IH}}, \mathrm{I}_{\mathrm{IL}}$ | $\mathrm{V}_{\text {IN }}=3.6 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 2.7 V |  | 0.004 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 0.5 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 2.5-V Supply (continued)

$\mathrm{V}_{+}=2.3 \mathrm{~V}$ to $2.7 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | TA | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | $\mathrm{t}_{\mathrm{on}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 2.6 | 47 |  |
|  |  |  |  | Full | $\begin{aligned} & 2.3 \mathrm{~V} \text { to } \\ & 2.7 \mathrm{~V} \end{aligned}$ |  |  | 50 | ns |
| Turn-off time | toff | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 16.5 | 34 |  |
|  |  |  |  | Full | $\begin{gathered} 2.3 \mathrm{~V} \text { to } \\ 2.7 \mathrm{~V} \end{gathered}$ |  |  | 35 | ns |
| Break-beforemake time | $t_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 2.5 V | 4 | 15 | 35 | ns |
|  |  |  |  | Full | $\begin{aligned} & 2.3 \mathrm{~V} \text { to } \\ & 2.7 \mathrm{~V} \end{aligned}$ | 3 |  | 35 |  |
| Charge injection | $Q_{C}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=1 \mathrm{nF}$ | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 84 |  | pC |
| NC, NO OFF capacitance | $\mathrm{C}_{\text {NC(OFF) }}$, $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 52 |  | pF |
| NC, NO ON capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{ON})}$, <br> $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 163 |  | pF |
| COM ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{V}_{\text {COM }}=\mathrm{V}_{+}$or GND, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 163 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND |  | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 2.5 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 35 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch OFF | $25^{\circ} \mathrm{C}$ | 2.5 V |  | -71 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch ON | $25^{\circ} \mathrm{C}$ | 2.5 V |  | -73 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\mathrm{f}=20 \mathrm{~Hz}$ to 20 kHz | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 0.009 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | $25^{\circ} \mathrm{C}$ | 2.5 V |  | 0.004 | 0.1 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 0.5 |  |

TS3A44159
0.45- $\Omega$ QUAD SPDT ANALOG SWITCH

QUAD-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER WITH TWO CONTROLS
SCDS225-MARCH 2007

## Electrical Characteristics for 1.8-V Supply ${ }^{(1)}$

$\mathrm{V}_{+}=1.65 \mathrm{~V}$ to $1.95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{T}_{\mathrm{A}}$ | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Switch |  |  |  |  |  |  |  |  |  |
| Analog signal range | $\begin{gathered} \mathrm{V}_{\mathrm{COM}}, \\ \mathrm{v}_{\mathrm{NO}}, \mathrm{~V}_{\mathrm{NC}} \end{gathered}$ |  |  |  |  | 0 |  | $\mathrm{V}_{+}$ | $\Omega$ |
| ON-state resistance | $\mathrm{r}_{\text {on }}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}$, $\mathrm{I}_{\text {сом }}=-100 \mathrm{~mA}$, | Switch ON, <br> See Figure 17 | $25^{\circ} \mathrm{C}$ | 1.65 V |  | 0.5 | 0.7 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.8 |  |
| ON-state resistance match between channels | $\Delta r_{\text {on }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, 0.6 \mathrm{~V} \\ & \mathrm{I}_{\mathrm{COM}}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 17 | $25^{\circ} \mathrm{C}$ | 1.65 V |  | 0.05 | 0.07 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.1 |  |
| ON-state resistance flatness | $\mathrm{r}_{\text {on(flat) }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.5 \mathrm{~V}, 0.6 \mathrm{~V} \\ & 1.5 \mathrm{~V}, 2.5 \mathrm{~V}, \\ & \mathrm{I}_{\text {COM }}=-100 \mathrm{~mA}, \end{aligned}$ | Switch ON, See Figure 18 | $25^{\circ} \mathrm{C}$ | 1.65 V |  | 0.5 | 0.7 | $\Omega$ |
|  |  |  |  | Full |  |  |  | 0.8 |  |
| NC, NO OFF leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{OFF})}$, $\mathrm{I}_{\mathrm{NC}(\mathrm{OFF})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=1.65 \mathrm{~V}, \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.65 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=0.3 \mathrm{~V}, \end{aligned}$ | See Figure 18 | $25^{\circ} \mathrm{C}$ | 1.95 V | -10 | 0.5 | 10 |  |
|  |  |  |  | Full |  | -20 |  | 20 | nA |
| NC, NO ON leakage current | $\mathrm{I}_{\mathrm{NO}(\mathrm{ON})}$, $\mathrm{I}_{\mathrm{NC}(\mathrm{ON})}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=0.3 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\mathrm{Open}, \\ & \text { or } \\ & \mathrm{V}_{\mathrm{NO}} \text { or } \mathrm{V}_{\mathrm{NC}}=1.65 \mathrm{~V}, \\ & \mathrm{~V}_{\mathrm{COM}}=\mathrm{Open}, \end{aligned}$ | See Figure 19 | $25^{\circ} \mathrm{C}$ | 1.95 V | -10 | 0.1 | 10 |  |
|  |  |  |  | Full |  | -20 |  | 20 | nA |
| COM ON leakage current | $\mathrm{I}_{\text {COM (ON) }}$ | $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\text {COM }}=0.3 \mathrm{~V}$, <br> or <br> $\mathrm{V}_{\mathrm{NO}}$ or $\mathrm{V}_{\mathrm{NC}}=$ Open, <br> $\mathrm{V}_{\mathrm{COM}}=1.65 \mathrm{~V}$, | See Figure 19 | $25^{\circ} \mathrm{C}$ | 1.95 V | -10 | 0.1 | 10 |  |
|  |  |  |  | Full |  | -20 |  | 20 | nA |
| Digital Control Inputs (IN1-2, IN3-4) ${ }^{(2)}$ |  |  |  |  |  |  |  |  |  |
| Input logic high | $\mathrm{V}_{\mathrm{H}}$ |  |  | Full |  | 1 |  | 5.5 | V |
| Input logic low | $\mathrm{V}_{\mathrm{IL}}$ |  |  | Full |  | 0 |  | 0.4 | V |
| Input leakage current | $I_{\text {IH }}, \mathrm{I}_{\text {IL }}$ | $\mathrm{V}_{\mathrm{IN}}=3.6 \mathrm{~V}$ or 0 |  | $25^{\circ} \mathrm{C}$ | 1.95 V |  | 0.04 | 5 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 50 |  |

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum
(2) All unused digital inputs of the device must be held at $\mathrm{V}_{+}$or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

## Electrical Characteristics for 1.8-V Supply (continued)

$\mathrm{V}_{+}=1.65 \mathrm{~V}$ to $1.95 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=-40^{\circ} \mathrm{C}$ to $85^{\circ} \mathrm{C}$ (unless otherwise noted)

| PARAMETER | SYMBOL | TEST CONDITIONS |  | $\mathrm{T}_{\text {A }}$ | $\mathrm{V}_{+}$ | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dynamic |  |  |  |  |  |  |  |  |  |
| Turn-on time | $\mathrm{t}_{\mathrm{ON}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 40 | 70 |  |
|  |  |  |  | Full | $\begin{aligned} & 1.65 \mathrm{~V} \text { to } \\ & 1.95 \mathrm{~V} \end{aligned}$ |  |  | 75 | ns |
| Turn-off time | $\mathrm{t}_{\text {OFF }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 22 | 45 |  |
|  |  |  |  | Full | $\begin{aligned} & 1.65 \mathrm{~V} \text { to } \\ & 1.95 \mathrm{~V} \end{aligned}$ |  |  | 50 | ns |
| Break-beforemake time | $\mathrm{t}_{\text {BBM }}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{NC}}=\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}, \\ & \mathrm{R}_{\mathrm{L}}=50 \Omega, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=35 \mathrm{pF}$ | $25^{\circ} \mathrm{C}$ | 1.8 V | 5 | 25 | 70 | ns |
|  |  |  |  | Full | $\begin{gathered} 1.65 \mathrm{~V} \text { to } \\ 1.95 \mathrm{~V} \end{gathered}$ | 4 |  | 75 |  |
| Charge injection | $\mathrm{Q}_{\mathrm{C}}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{GEN}}=0, \\ & \mathrm{R}_{\mathrm{GEN}}=0, \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=1 \mathrm{nF}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 64 |  | pC |
| NC, NO OFF capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{OFF})}$, $\mathrm{C}_{\mathrm{NO} \text { (OFF) }}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND, Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 52 |  | pF |
| NC, NO ON capacitance | $\mathrm{C}_{\mathrm{NC}(\mathrm{ON})}$, <br> $\mathrm{C}_{\mathrm{NO}(\mathrm{ON})}$ | $\mathrm{V}_{\mathrm{NC}}$ or $\mathrm{V}_{\mathrm{NO}}=\mathrm{V}_{+}$or GND , Switch OFF, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 164 |  | pF |
| COM <br> ON capacitance | $\mathrm{C}_{\text {COM(ON) }}$ | $\mathrm{V}_{\mathrm{COM}}=\mathrm{V}_{+} \text {or GND, }$ Switch ON, | See Figure 17 | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 164 |  | pF |
| Digital input capacitance | $\mathrm{C}_{1}$ | $\mathrm{V}_{1}=\mathrm{V}_{+}$or GND |  | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 2.5 |  | pF |
| Bandwidth | BW | $\mathrm{R}_{\mathrm{L}}=50 \Omega$, | Switch ON | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 35 |  | MHz |
| OFF isolation | $\mathrm{O}_{\text {ISO }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch OFF | $25^{\circ} \mathrm{C}$ | 1.8 V |  | -71 |  | dB |
| Crosstalk | $\mathrm{X}_{\text {TALK }}$ | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=50 \Omega, \\ & \mathrm{f}=100 \mathrm{kHz}, \end{aligned}$ | Switch ON | $25^{\circ} \mathrm{C}$ | 1.8 V |  | -73 |  | dB |
| Total harmonic distortion | THD | $\begin{aligned} & \mathrm{R}_{\mathrm{L}}=600 \Omega, \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \end{aligned}$ | $\begin{aligned} & \mathrm{f}=20 \mathrm{~Hz} \text { to } \\ & 20 \mathrm{kHz} \end{aligned}$ | $25^{\circ} \mathrm{C}$ | 1.8 V |  | 0.1 |  | \% |
| Supply |  |  |  |  |  |  |  |  |  |
| Positive supply current | $I_{+}$ | $\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{+}$or GND, | Switch ON or OFF | 25 C | 1.95 V |  | 0.001 | 0.05 | $\mu \mathrm{A}$ |
|  |  |  |  | Full |  |  |  | 0.15 |  |

TYPICAL PERFORMANCE


Figure 1. $r_{\text {on }}$ vs $V_{\text {com }}$ $\left(\mathrm{V}_{+}=1.65 \mathrm{~V}\right)$


Figure 3. $\mathrm{r}_{\text {on }} \mathrm{vs} \mathrm{V}_{\text {com }}$
$\left(\mathrm{V}_{+}=3 \mathrm{~V}\right)$


Figure 5. $r_{\text {on }}$ vs $V_{\text {com }}$
(All Voltages)


Figure 2. $r_{\text {on }}$ vs $V_{\text {com }}$ $\left(\mathrm{V}_{+}=2.3 \mathrm{~V}\right)$


Figure 4. $\mathrm{r}_{\mathrm{on}} \mathrm{vs} \mathrm{V}_{\text {com }}$
( $\mathrm{V}_{+}=4.3 \mathrm{~V}$ )


Figure 6. Charge Injection $\left(Q_{C}\right)$ vs $\mathrm{V}_{\text {com }}$
( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )

## TYPICAL PERFORMANCE (continued)



Figure 7. $\mathrm{t}_{\mathrm{ON}}$ and $\mathrm{t}_{\text {OFF }}$ vs Supply Voltage
( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ )


Figure 9. Control Input Threshold Voltage


Figure 11. OFF Isolation


Figure 8. $t_{\text {ON }}$ and $t_{\text {OFF }}$ vs Temperature $\left(V_{+}=4.3 \mathrm{~V}\right)$


Figure 10. Bandwidth


Figure 12. Crosstalk
$0.45-\Omega$ QUAD SPDT ANALOG SWITCH

QUAD-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER WITH TWO CONTROLS
TYPICAL PERFORMANCE (continued)


Figure 13. Total Harmonic Distortion vs Frequency ( $\mathrm{V}_{+}=1.8 \mathrm{~V}$ )


Figure 15. Total Harmonic Distortion vs Frequency $\left(\mathrm{V}_{+}=3.3 \mathrm{~V}\right)$


Figure 14. Total Harmonic Distortion vs Frequency $\left(\mathrm{V}_{+}=2.5 \mathrm{~V}\right)$


Figure 16. Total Harmonic Distortion vs Frequency $\left(\mathrm{V}_{+}=4.3 \mathrm{~V}\right)$

## PARAMETER MEASUREMENT INFORMATION



Figure 17. ON-state Resistance (ron)


OFF-State Leakage Current
Channel OFF
$\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{\mathrm{IH}}$ or $\mathrm{V}_{\mathrm{IL}}$

Figure 18. OFF-State Leakage Current
( $\left.I_{\text {NC(OFF) }}, I_{\text {NC(PWROFF) }}, I_{\text {NO(OFF) }}, I_{\text {NO(PWROFF) }}, I_{\text {COM(OFF) }}, I_{\text {COM(PWROFF) }}\right)$


Figure 19. ON-State Leakage Current

## PARAMETER MEASUREMENT INFORMATION (continued)


$\mathrm{V}_{\mathrm{BIAS}}=\mathrm{V}_{+}$or GND
$\mathrm{V}_{\mathrm{I}}=\mathrm{V}_{+}$or GND
Capacitance is measured at NC, NO, COM, and IN inputs during ON and OFF conditions.

Figure 20. Capacitance
( $\left.\mathrm{C}_{\mathrm{l}}, \mathrm{C}_{\mathrm{COM}(\mathrm{ON})}, \mathrm{C}_{\mathrm{NC}(\mathrm{OFF})}, \mathrm{C}_{\mathrm{NO}(\mathrm{OFF})}, \mathrm{C}_{\mathrm{NC}(\mathrm{ON})}, \mathrm{C}_{\mathrm{NO}(\mathrm{ON})}\right)$

(1) All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}}<5 \mathrm{~ns}$, $\mathrm{t}_{\mathrm{f}}<5 \mathrm{~ns}$.
(2) $C_{L}$ includes probe and jig capacitance.

Figure 21. Turn-On ( $\mathrm{t}_{\mathrm{ON}}$ ) and Turn-Off Time ( $\mathrm{t}_{\mathrm{OFF}}$ )

## PARAMETER MEASUREMENT INFORMATION (continued)


(1) $C_{L}$ includes probe and jig capacitance.
(2) All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega, \mathrm{t}_{\mathrm{r}}<5 \mathrm{~ns}$, $\mathrm{t}_{\mathrm{f}}<5 \mathrm{~ns}$.

Figure 22. Break-Before-Make Time ( $\mathrm{t}_{\mathrm{BB}}$ )


Figure 23. Bandwidth (BW)

## PARAMETER MEASUREMENT INFORMATION (continued)



Figure 24. OFF Isolation ( $\mathrm{O}_{\text {Iso }}$ )


Figure 25. Crosstalk ( $\mathrm{X}_{\text {taLK }}$ )

## PARAMETER MEASUREMENT INFORMATION (continued)


(1) All input pulses are supplied by generators having the following characteristics: $\mathrm{PRR} \leq 10 \mathrm{MHz}, \mathrm{Z}_{\mathrm{O}}=50 \Omega$, $\mathrm{t}_{\mathrm{r}}<5 \mathrm{~ns}$, $\mathrm{t}_{\mathrm{f}}<5 \mathrm{~ns}$.
(2) $C_{L}$ includes probe and jig capacitance.

Figure 26. Charge Injection $\left(Q_{C}\right)$

(1) $C_{L}$ includes probe and jig capacitance.

Figure 27. Total Harmonic Distortion (THD)
www.ti.com
25-Sep-2007

PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3A44159PWR | ACTIVE | TSSOP | PW | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \\ \hline \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| TS3A44159PWRG4 | ACTIVE | TSSOP | PW | 16 | 2000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no } \mathrm{Sb} / \mathrm{Br}) \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| TS3A44159RGTR | ACTIVE | QFN | RGT | 16 | 3000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |
| TS3A44159RGTRG4 | ACTIVE | QFN | RGT | 16 | 3000 | $\begin{gathered} \text { Green (RoHS \& } \\ \text { no Sb/Br) } \end{gathered}$ | CU NIPDAU | Level-1-260C-UNLIM |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS \& no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb -Free/Green conversion plan has not been defined.
Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb -Free products are suitable for use in specified lead-free processes.
Pb -Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS \& no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants ( Br or Sb do not exceed $0.1 \%$ by weight in homogeneous material)
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer:The information provided on this page represents Tl's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## TAPE AND REEL BOX INFORMATION

REEL DIMENSIONS


TAPE DIMENSIONS


| A0 | Dimension designed to accommodate the component width |
| :--- | :--- |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


| Device | Package | Pins | Site | Reel <br> Diameter <br> $(\mathbf{m m})$ | Reel <br> Width <br> $(\mathbf{m m})$ | $\mathbf{A 0}(\mathbf{m m})$ | B0 (mm) | K0 (mm) | P1 <br> $(\mathbf{m m})$ | W <br> $(\mathbf{m m})$ | Pin1 <br> Quadrant |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3A44159PWR | PW | 16 | SITE 41 | 330 | 12 | 7.0 | 5.6 | 1.6 | 8 | 12 | Q1 |

PACKAGE MATERIALS INFORMATION
INSTRUMENTS


| Device | Package | Pins | Site | Length (mm) | Width (mm) | Height (mm) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TS3A44159PWR | PW | 16 | SITE 41 | 346.0 | 346.0 | 29.0 |



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. Quad Flatpack, No-leads (QFN) package configuration.

The package thermal pad must be soldered to the board for thermal and mechanical performance.
See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
E. Falls within JEDEC MO-220.

## THERMAL PAD MECHANICAL DATA <br> RGT (S-PQFP-N16)

## THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).
For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, Quad Flatpack No-Lead Logic Packages, Texas Instruments Literature No. SCBA017. This document is available at www.ti.com.

The exposed thermal pad dimensions for this package are shown in the following illustration.


Bottom View
NOTE: All linear dimensions are in millimeters

Exposed Thermal Pad Dimensions

## RGT (S-PQFP-N16)



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, Quad Flat-Pack Packages, Texas Instruments Literature No. SCBA017, SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at www.ti.com <http: //www.ti.com>.
E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
F. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.


NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
B. This drawing is subject to change without notice.
C. QFN (Quad Flatpack No-Lead) package configuration.
D. This package complies to JEDEC MO-288 variation UFHE, except minimum package thickness.


NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Publication IPC-7351 is recommended for alternate designs.
D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
E. Maximum stencil thickness $0,127 \mathrm{~mm}$ ( 5 mils). All linear dimensions are in millimeters.
F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
G. Side aperture dimensions over-print land for acceptable area ratio $>0.66$. Customer may reduce side aperture dimensions if stencil manufacturing process allows for sufficient release at smaller opening.


| PIM PINS $^{* *}$ | $\mathbf{8}$ | $\mathbf{1 4}$ | $\mathbf{1 6}$ | $\mathbf{2 0}$ | $\mathbf{2 4}$ | $\mathbf{2 8}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| A MAX | 3,10 | 5,10 | 5,10 | 6,60 | 7,90 | 9,80 |
| A MIN | 2,90 | 4,90 | 4,90 | 6,40 | 7,70 | 9,60 |

NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0,15 .
D. Falls within JEDEC MO-153

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to Tl's terms and conditions of sale supplied at the time of order acknowledgment.
TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with Tl's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.
TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.
TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.
Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.
TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.
TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.
Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

| Products |  | Applications |  |
| :---: | :---: | :---: | :---: |
| Amplifiers | amplifier.ti.com | Audio | www.ti.com/audio |
| Data Converters | dataconverter.ti.com | Automotive | www.ti.com/automotive |
| DSP | dsp.ti.com | Broadband | www.ti.com/broadband |
| Interface | interface.ti.com | Digital Control | www.ti.com/digitalcontrol |
| Logic | logic.ti.com | Military | www.ti.com/military |
| Power Mgmt | power.ti.com | Optical Networking | www.ti.com/opticalnetwork |
| Microcontrollers | microcontroller.ti.com | Security | www.ti.com/security |
| RFID | www.ti-rfid.com | Telephony | www.ti.com/telephony |
| Low Power Wireless | www.ti.com/lpw | Video \& Imaging | www.ti.com/video |
|  |  | Wireless | www.ti.com/wireless |


[^0]:    DF
    Please be aware that an important notice concerning availability，standard warranty，and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet．

